

1.0 Scope

This specification documents the detail requirements for space qualified product manufactured on Analog Devices, Inc.'s QML certified line per MIL-PRF-38535 Level V except as modified herein.

The manufacturing flow described in the STANDARD SPACE LEVEL PRODUCTS PROGRAM brochure is to be considered a part of this specification. <http://www.analog.com/aerospace>.

This data sheet specifically details the space grade version of this product. A more detailed operational description and a complete data sheet for commercial product grades can be found at www.analog.com/AD9814.

2.0 Part Number. The complete part number(s) of this specification follow:

<u>Part Number</u>	<u>Description</u>
AD9814-703F	Complete 14-Bit CCD/CIS Signal Processor

3.0 Case Outline

<u>Letter</u>	<u>Descriptive designator</u>	<u>Case Outline (Lead Finish per MIL-PRF-38535)</u>
F	CDFP3-F28	28 lead bottom-brazed flatpack

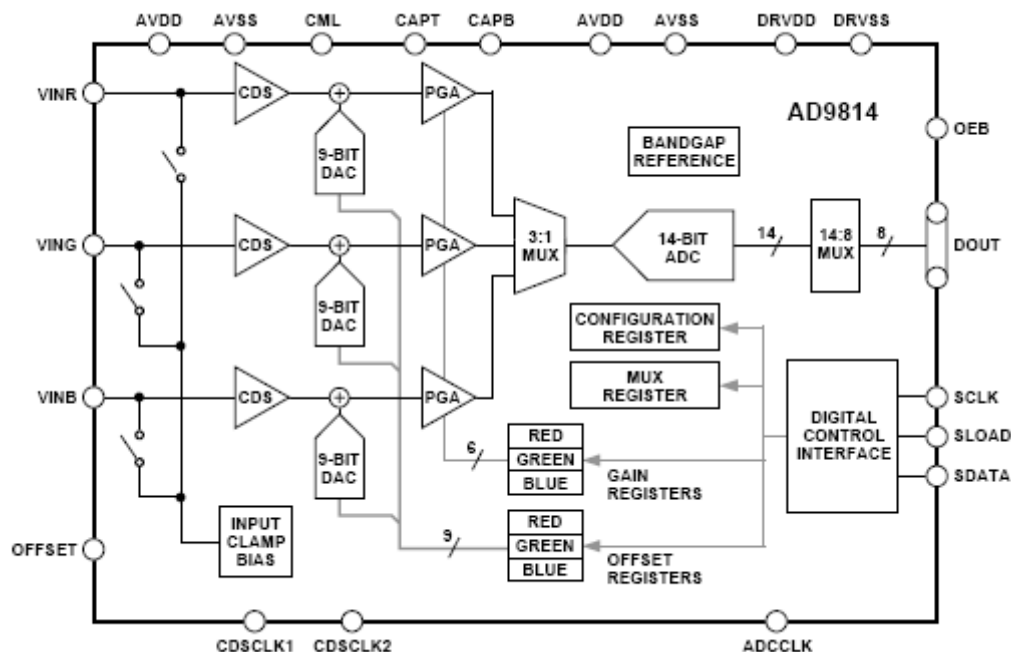


Figure 1 - Functional Block Diagram

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Rev. D

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One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106,
U.S.A.

Tel: 781.329.4700

www.analog.com

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AD9814S

<u>Pin Number</u>	<u>Name</u>	<u>Type</u>	<u>Description</u>
1	CDSCLK1	DI	CDS Reference Level Sampling Clock
2	CDSCLK2	DI	CDS Data Level Sampling Clock
3	ADCCLK	DI	A/D Converter Sampling Clock
4	OEB	DI	Output Enable, Active Low
5	DRVDD	P	Digital Output Driver Supply
6	DRVSS	P	Digital Output Driver Ground
7	D7	DO	Data Output MSB. ADC DB13 High Byte, ADC DB5 Low Byte
8	D6	DO	Data Output. ADC DB12 High Byte, ADC DB4 Low Byte
9	D5	DO	Data Output. ADC DB11 High Byte, ADC DB3 Low Byte
10	D4	DO	Data Output. ADC DB10 High Byte, ADC DB2 Low Byte
11	D3	DO	Data Output. ADC DB9 High Byte, ADC DB1 Low Byte
12	D2	DO	Data Output. ADC DB8 High Byte, ADC DB0 Low Byte
13	D1	DO	Data Output. ADC DB7 High Byte, Don't Care Low Byte
14	D0	DO	Data Output LSB. ADC DB6 High Byte, Don't Care Low Byte
15	SDATA	DI/DO	Serial Interface Data Input/Output
16	SCLK	DI	Serial Interface Clock Input
17	SLOAD	DI	Serial Interface Load Pulse
18	AVDD	P	+5 V Analog Supply
19	AVSS	P	Analog Ground
20	CAPB	AO	ADC Bottom Reference Voltage Decoupling
21	CAPT	AO	ADC Top Reference Voltage Decoupling
22	VINB	AI	Analog Input, Blue Channel
23	CML	AO	Internal Bias Level Decoupling
24	VING	AI	Analog Input, Green Channel
25	OFFSET	AO	Clamp Bias Level Decoupling
26	VINR	AI	Analog Input, Red Channel
27	AVSS	P	Analog Ground
28	AVDD	P	+5 V Analog Supply

Type: AI = Analog Input, AO = Analog Output, DI = Digital Input, DO = Digital Output, P = Power.

Figure 2 – Terminal Connections and Pin Function Descriptions

4.0 Absolute Maximum Ratings. ($T_A = 25^\circ\text{C}$, unless otherwise noted)

<u>Parameter</u>	<u>With respect to</u>	<u>Min</u>	<u>Max</u>	<u>Units</u>
VIN, CAPT, CAPB	AVSS	-0.3	AVDD + 0.3	V
Digital Inputs	AVSS	-0.3	AVDD + 0.3	V
AVDD	AVSS	-0.5	+6.5	V
DRVDD	DRVSS	-0.5	+6.5	V
AVSS	DRVSS	-0.3	+0.3	V
Digital Outputs	DRVSS	-0.3	DRVDD + 0.3	V
Junction Temperature			+150	$^\circ\text{C}$
Storage Temperature		-65	+150	$^\circ\text{C}$
Lead Temperature (10 sec)			+300	$^\circ\text{C}$

NOTES:

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

The input limits are defined as maximum tolerable voltage levels into the AD9814. These levels are not intended to be in the linear input range of the device. Signals beyond the input limits will turn on the overvoltage protection diodes.

5.0 Thermal Characteristics:

Package Type	Junction-to-Case (Θ_{JC})	Junction-to-Ambient (Θ_{JA})	Units
Thermal Resistance, Bottom Brazed (F)	22	60	$^\circ\text{C}/\text{W Max}$

AD9814S

6.0 Table I. Electrical Table:

Table I						
Parameter See notes at end of table	Symbol	Conditions ^{1/} Unless Otherwise Specified	Sub Group	Limit Min	Limit Max	Units
RESOLUTION	RES	No Missing Codes	1,2,3	14		Bits
Supply Currents	I _{AVDD}		1,2,3		80	mA
	I _{DRVDD}		1,2,3		10	mA
Power dissipation	PD		1,2,3		450	mW
Power supply rejection	PSR	AVDD= +5.0V ± 0.25V	1,2		0.3	%FSR
			3		0.5	%FSR
ACCURACY (Entire Signal Path) Integral Nonlinearity ^{2/}	INL		1,2	-11	11	LSB
			3	-18	11	LSB
ACCURACY (Entire Signal Path) Differential Nonlinearity	DNL		1	-1	1.25	LSB
			2	-1	1	LSB
			3	-1	1.5	LSB
ACCURACY (Entire Signal Path) Offset Error	VOS		1,2,3	-104	104	mV
ACCURACY (Entire Signal Path) Gain Error ^{3/}	GAIN		1,2,3	-5.3	5.3	%FSR
PGA Gain Ratio ^{4/}	PGA GAIN		1,2,3	5.7	5.9	
DIFFERENTIAL VREF CAPT-CAPB (4V Input Range)	VREF4		1,2,3	1.9	2.1	V
DIFFERENTIAL VREF CAPT-CAPB (2V Input Range)	VREF2		1,2,3	0.94	1.06	V

TABLE I NOTES:

- 1/ $T_A = +25\text{ }^\circ\text{C}$, $T_A \text{ Max} = +125\text{ }^\circ\text{C}$, $T_A \text{ Min} = -55\text{ }^\circ\text{C}$. AVDD = +5 V, DRVDD = +5 V, 3-Channel CDS, $F_{\text{ADCCLK}} = 6\text{ MHz}$, $F_{\text{CDSCLK1}} = F_{\text{CDSCLK2}} = 2\text{ MHz}$, PGA Gain = 1, Input Range = 4V, unless otherwise noted.
- 2/ INL is measured using the “fixed endpoint” method, NOT using a “best-fit” calculation.
- 3/ The Gain Error specification is dominated by the tolerance of the internal differential voltage reference.
- 4/ The PGA Gain is approximately “linear in dB” and follows the equation: $\text{PGA Gain} = (5.8 / (1 + 4.8 (63 - G) / 63))$ where G is the register value.

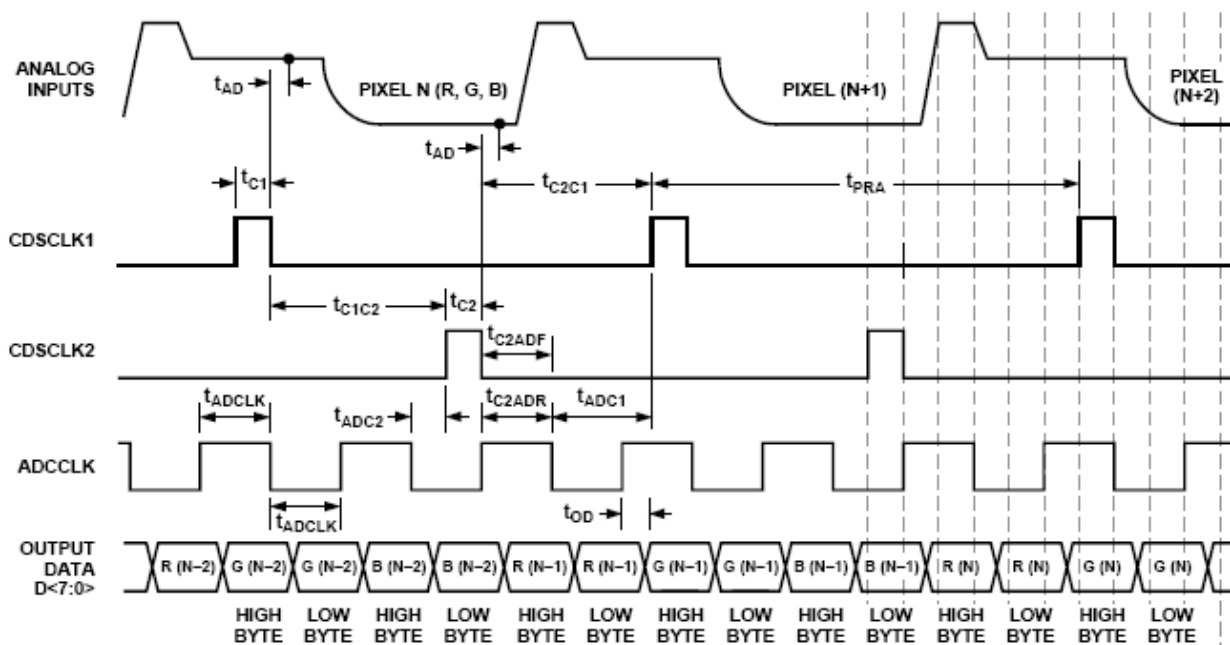


Figure 3 – 3-Channel CDS Mode Timing Diagram

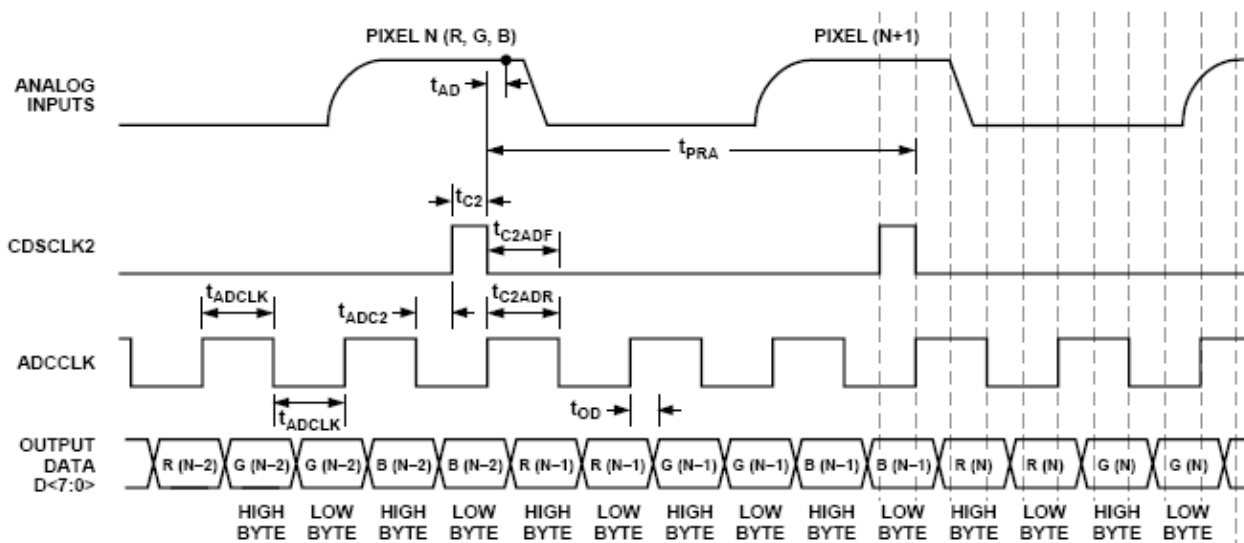


Figure 4 – 3-Channel SHA Mode Timing Diagram

6.0 Table II. Electrical Test Requirements:

Table II	
Test Requirements	Subgroups (in accordance with MIL-PRF-38535, Table III)
Interim Electrical Parameters	1
Final Electrical Parameters	1, 2, 3 <u>1/</u> <u>2/</u>
Group A Test Requirements	1, 2, 3
Group C end-point electrical parameters	1 <u>2/</u>
Group D end-point electrical parameters	1
Group E end-point electrical parameters	N/A

Notes:

1/ PDA applies to Subgroup 1. Delta's excluded from PDA.

2/ See Table III for Delta limits.

7.0 Table III. Life Test / Burn-in Delta limits:

Table III		
<u>Test Symbol</u>	<u>Delta Limit</u>	<u>Units</u>
IAVDD	+/-2	mA
VOS	+/-13.2 (+/-54)	mV (LSB)
GAIN	+/-0.56 (+/-91)	% (LSB)
+INL	+/-6	LSB
-INL	+/-5	LSB
+DNL	+/-0.5	LSB
-DNL	+/-0.35	LSB

8.0 Life Test / Burn-In Circuit:

8.1 HTRB is not applicable for this drawing.

8.2 Burn-in is per MIL-STD-883 Method 1015, test condition D.

8.3 Steady state life test is per MIL-STD-883 Method 1005, test condition D.

9.0 MIL-STD-38535 QMLV exceptions:

9.1 Full WLA per MIL-STD-883 TM 5007 is not available for this product. SEM Inspection only is available per MIL-STD-883, TM2018.

9.2 This product is manufactured in a MIL-PRF-38535 QMLQ certified wafer fab facility.

Rev	Description of Change	Date
A	Initiate	Sept 9, 2007
B	Update header/footer and add to 1.0 Scope description.	March 7, 2008
C	Add reference notations to Section 4.0, Table I	April 7, 2008
D	Remove post Group C specification limits in Table III such that only Delta limits are listed. Remove QMLV exception for testing in QMLQ facility. Add Figure 2 pin descriptions. Formatting improvements.	March 24, 2010



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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9